
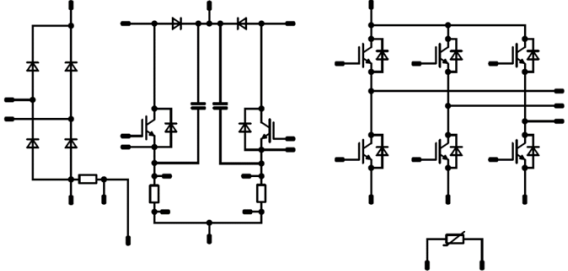




Vincotech

<i>flowPIM 1 + PFC</i>	600 V / 50 A
<div style="background-color: #eee; padding: 5px; margin-bottom: 5px;"><b>Features</b></div> <ul style="list-style-type: none"> <li>One-phase rectifier</li> <li>Interleaved PFC circuit</li> <li>High speed IGBT in the inverter</li> <li>Integrated shunts and capacitors</li> </ul>	<div style="background-color: #eee; padding: 5px; margin-bottom: 5px;"><i>flow 1 12 mm housing</i></div> 
<div style="background-color: #eee; padding: 5px; margin-bottom: 5px;"><b>Target applications</b></div> <ul style="list-style-type: none"> <li>Embedded Drives</li> <li>Industrial Drives</li> </ul>	<div style="background-color: #eee; padding: 5px; margin-bottom: 5px;"><b>Schematic</b></div> 
<div style="background-color: #eee; padding: 5px; margin-bottom: 5px;"><b>Types</b></div> <ul style="list-style-type: none"> <li>10-PG06PPA050SJ-LJ04B08T</li> </ul>	

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Rectifier Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	85	A
Surge (non-repetitive) forward current	$I_{FSM}$	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	890	A
Surge current capability	$I^2t$		3960	$A^2s$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	108	W
Maximum junction temperature	$T_{jmax}$		150	$^{\circ}C$



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter Switch</b>				
Collector-emitter voltage	$V_{CES}$		600	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	48	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	150	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	81	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ $V_{ce} = 400\text{ V}$ $T_j = 150\text{ °C}$	5	$\mu\text{s}$
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$
<b>Inverter Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		600	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	35	A
Repetitive peak forward current	$I_{FRM}$		60	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	58	W
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$
<b>PFC Switch</b>				
Collector-emitter voltage	$V_{CES}$		650	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	150	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	81	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$
<b>PFC Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		650	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	49	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	84	W
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### PFC Sw. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	14	A
Repetitive peak forward current	$I_{FRM}$		20	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	W
Maximum junction temperature	$T_{jmax}$		175	°C

### Capacitor (PFC)

Maximum DC voltage	$V_{MAX}$		630	V
Operation Temperature	$T_{op}$		-55...+125	°C

### PFC Shunt

Max DC current	$I_{MAX}$	$T_c = 25\text{ °C}$	32	A
Power dissipation	$P_{tot}$	$T_c = 70\text{ °C}$	2	W

### Shunt

Max DC current	$I_{MAX}$	$T_c = 25\text{ °C}$	32	A
Power dissipation	$P_{tot}$	$T_c = 70\text{ °C}$	2	W

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...(T <sub>jmax</sub> - 25)	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min. 12,7	mm
Clearance			7,82	mm
Comparative Tracking Index	CTI		> 200	

\*100 % tested in production



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### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Rectifier Diode

##### Static

Forward voltage	$V_F$			60	25 125		1,04 0,97	1,5	V
Reverse leakage current	$I_R$		1600		25 150			100 2000	$\mu$ A

##### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					0,65		K/W
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## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Inverter Switch

#### Static

Parameter	Symbol	Conditions	$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$				0,0008	25	4,1	5,1	5,7	V
Collector-emitter saturation voltage	$V_{CEsat}$		15			50	25 125 150		1,48 1,60 1,64	2	V
Collector-emitter cut-off current	$I_{CES}$		0	600			25			67	μA
Gate-emitter leakage current	$I_{GES}$		20	0			25			200	nA
Internal gate resistance	$r_g$								none		Ω
Input capacitance	$C_{ies}$								1950		pF
Output capacitance	$C_{oes}$	$f = 1$ Mhz	0	25		25			83		
Reverse transfer capacitance	$C_{res}$								67		
Gate charge	$Q_g$		15	480	50		25		249		nC

#### Thermal

Parameter	Symbol	Conditions	$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)							1,18		K/W

#### Dynamic

Parameter	Symbol	Conditions	$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit	
Turn-on delay time	$t_{d(on)}$						25 125 150		70 70 71		ns	
Rise time	$t_r$	$R_{gon} = 8$ Ω $R_{goff} = 8$ Ω					25 125 150		45 43 43			
Turn-off delay time	$t_{d(off)}$						25 125 150		115 134 139			
Fall time	$t_f$						25 125 150		22 34 41			
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 1,6$ μC $Q_{tFWD} = 3,1$ μC $Q_{tFWD} = 3,6$ μC					25 125 150		1,838 2,198 2,277			mWs
Turn-off energy (per pulse)	$E_{off}$						25 125 150		0,536 0,839 0,941			



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## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V]	$I_C$ [A] $I_D$ [A]	$I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Inverter Diode

#### Static

Forward voltage	$V_F$				30	25 150		1,64 1,56	2,05	V
Reverse leakage current	$I_R$			600		25			27	μA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,63		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$					25 125 150		11 16 17		A
Reverse recovery time	$t_{rr}$					25 125 150		251 332 393		ns
Recovered charge	$Q_r$	$di/dt = 245$ A/μs $di/dt = 545$ A/μs $di/dt = 378$ A/μs	±15	350	50	25 125 150		1,615 3,089 3,567		μC
Reverse recovered energy	$E_{rec}$					25 125 150		0,406 0,762 0,892		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		76 88 101		A/μs



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## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	

### PFC Switch

#### Static

Parameter	Symbol	$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
Gate-emitter threshold voltage	$V_{GE(th)}$		$V_{GE} = V_{CE}$		0,0005	25	3,3	4	4,7	V
Collector-emitter saturation voltage	$V_{CEsat}$			15	50	25 125 150		1,51 1,65 1,69	2,35	V
Collector-emitter cut-off current	$I_{CES}$			0	650	25			40	μA
Gate-emitter leakage current	$I_{GES}$			20	0	25			120	nA
Internal gate resistance	$r_g$							none		Ω
Input capacitance	$C_{ies}$							3000		pF
Output capacitance	$C_{oes}$	$f = 1$ Mhz		0	25	25		50		
Reverse transfer capacitance	$C_{res}$							11		
Gate charge	$Q_g$			15	520	50	25		120	nC

#### Thermal

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)				1,17 K/W

#### Dynamic

Parameter	Symbol	$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$					25 125 150		15 13 15		ns
Rise time	$t_r$					25 125 150		6 7 8		
Turn-off delay time	$t_{d(off)}$					25 125 150		82 97 101		
Fall time	$t_f$					25 125 150		3 6 8		
Turn-on energy (per pulse)	$E_{on}$					25 125 150		0,429 0,668 0,690		
Turn-off energy (per pulse)	$E_{off}$					25 125 150		0,152 0,383 0,471		mWs



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## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V]	$I_C$ [A] $I_D$ [A]	$I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### PFC Diode

#### Static

Forward voltage	$V_F$			50	25 125 150		2,17 1,87 1,80	2,8		V
Reverse leakage current	$I_R$		650		25			10		$\mu$ A

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					1,14			K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$				25 125 150		63 83 92			A
Reverse recovery time	$t_{rr}$				25 125 150		17 47 54			ns
Recovered charge	$Q_r$	$di/dt = 6122$ A/ $\mu$ s $di/dt = 5344$ A/ $\mu$ s $di/dt = 4864$ A/ $\mu$ s	0 / 15	400	50	25 125 150	0,941 1,793 2,268			$\mu$ C
Reverse recovered energy	$E_{rec}$					25 125 150	0,212 0,370 0,547			mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150	14126 8573 6729			A/ $\mu$ s

### PFC Sw. Protection Diode

#### Static

Forward voltage	$V_F$			10	25 125		1,67 1,56	2		V
Reverse leakage current	$I_R$		650		25			0,14		$\mu$ A

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					2,87			K/W
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### Capacitor (PFC)

Capacitance	$C$						33			nF
Tolerance							-5	+5		%





### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V]	$I_C$ [A] $I_D$ [A]	$I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

#### PFC Shunt

Resistance	$R$						2		mΩ
Tolerance*							1		%
Temperature coefficient	tc				20 - 60			75	ppm/K

\* Nominal tolerance of the component as shown in manufacturer's datasheet. **Not tested in production**

#### Shunt

Resistance	$R$						2		mΩ
Tolerance*							1		%
Temperature coefficient	tc				20 - 60			75	ppm/K

\* Nominal tolerance of the component as shown in manufacturer's datasheet. **Not tested in production**

#### Thermistor

Rated resistance	$R$				25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$			100	-5		5	%
Power dissipation	$P$				25		5		mW
Power dissipation constant					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1$ %			25		3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1$ %			25		4000		K
Vincotech NTC Reference								I	

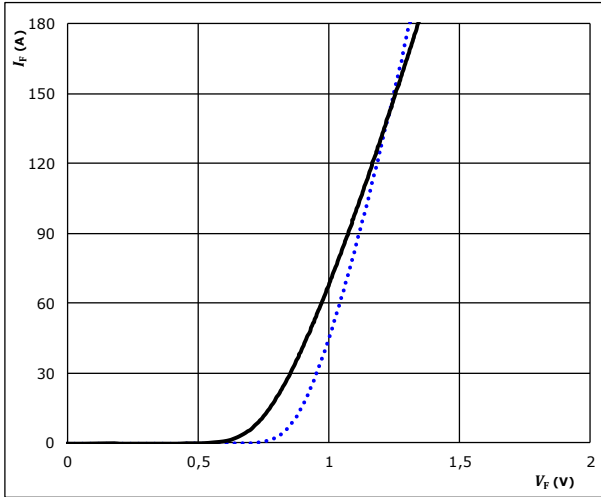


### Rectifier Diode Characteristics

**figure 1. Rectifier Diode**

Typical forward characteristics

$$I_F = f(V_F)$$

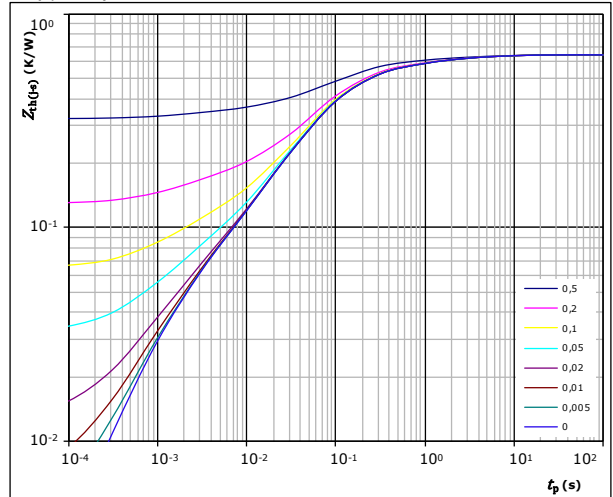


$t_p = 250 \mu s$   
 $T_j: 25 \text{ } ^\circ\text{C}$  (dotted blue line)  
 $125 \text{ } ^\circ\text{C}$  (solid black line)

**figure 2. Rectifier Diode**

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,65 \text{ K/W}$

Diode thermal model values

$R$ (K/W)	$\tau$ (s)
2,68E-02	6,32E+00
7,07E-02	1,29E+00
1,46E-01	2,31E-01
3,15E-01	6,56E-02
5,35E-02	9,74E-03
3,41E-02	1,27E-03

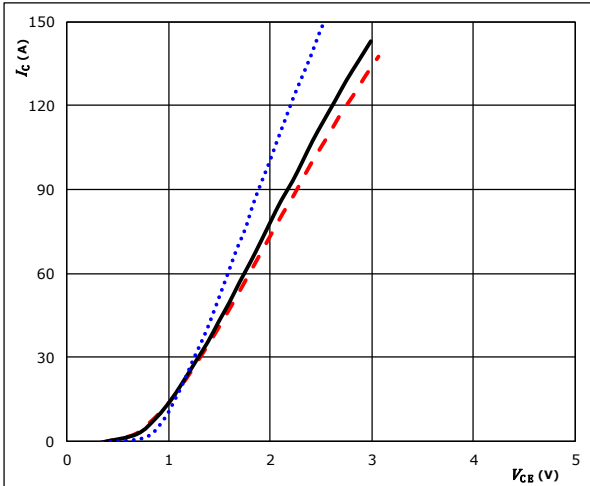


### Inverter Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$I_C = f(V_{CE})$

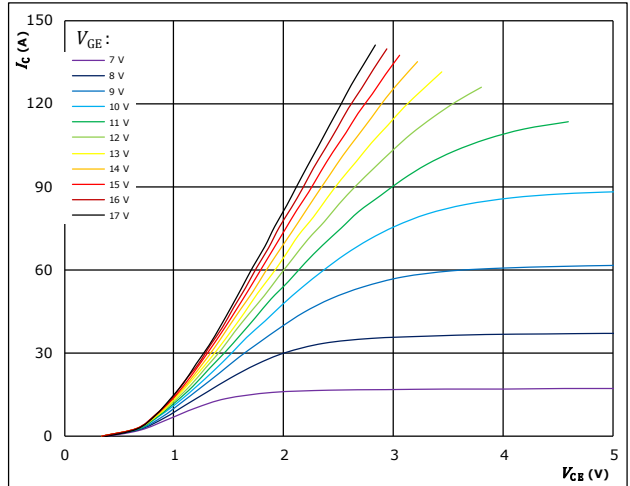


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ } ^\circ C$  (dotted blue line)  
 $125 \text{ } ^\circ C$  (solid black line)  
 $150 \text{ } ^\circ C$  (dashed red line)

**figure 2.** IGBT

Typical output characteristics

$I_C = f(V_{CE})$

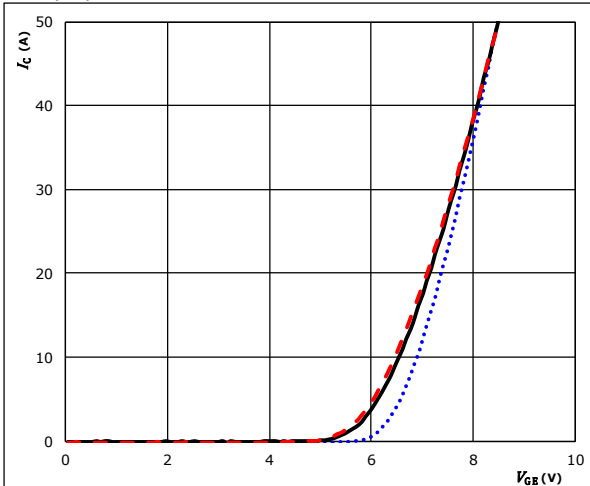


$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

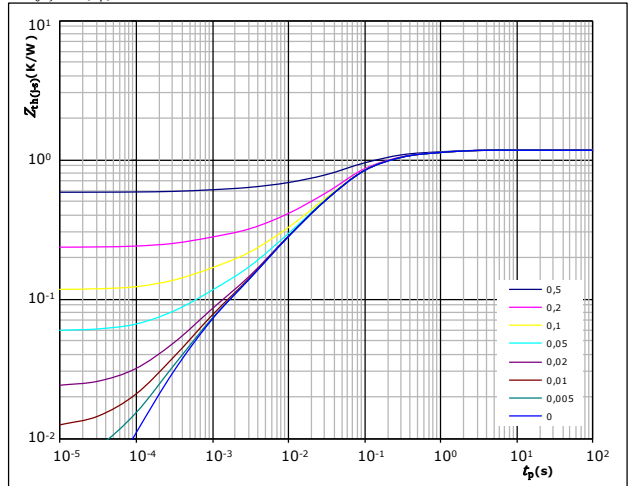


$t_p = 100 \mu s$   
 $V_{CE} = 10 V$   
 $T_j: 25 \text{ } ^\circ C$  (dotted blue line)  
 $125 \text{ } ^\circ C$  (solid black line)  
 $150 \text{ } ^\circ C$  (dashed red line)

**figure 4.** IGBT

Transient thermal impedance as function of pulse duration

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$   
 $R_{th(j-s)} = 1,18 \text{ K/W}$   
 IGBT thermal model values

$R$ (K/W)	$\tau$ (s)
1,28E-01	9,19E-01
3,00E-01	1,49E-01
5,67E-01	4,76E-02
1,34E-01	6,63E-03
4,70E-02	5,83E-04

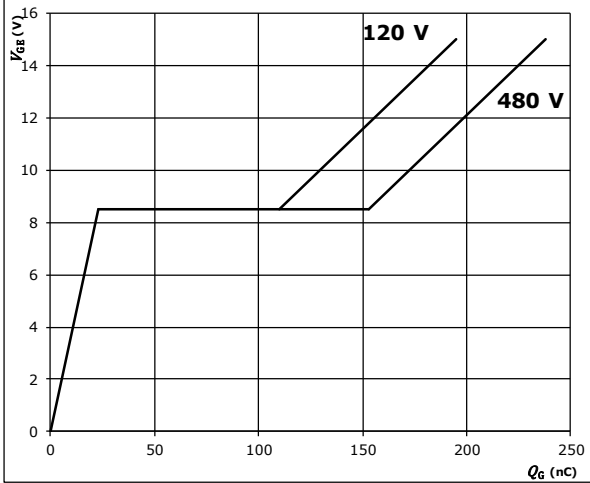


### Inverter Switch Characteristics

**figure 5.** IGBT

Gate voltage vs gate charge

$V_{GE} = f(Q_G)$

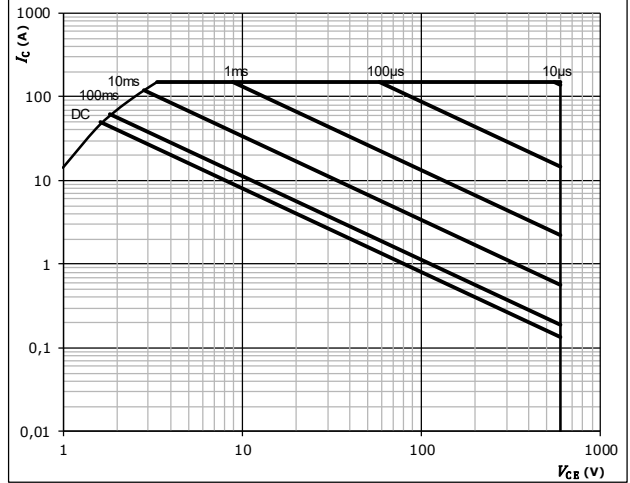


$I_C = 50 \text{ A}$

**figure 6.** IGBT

Safe operating area

$I_C = f(V_{CE})$



$D =$  single pulse  
 $T_s = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $T_j = T_{jmax}$

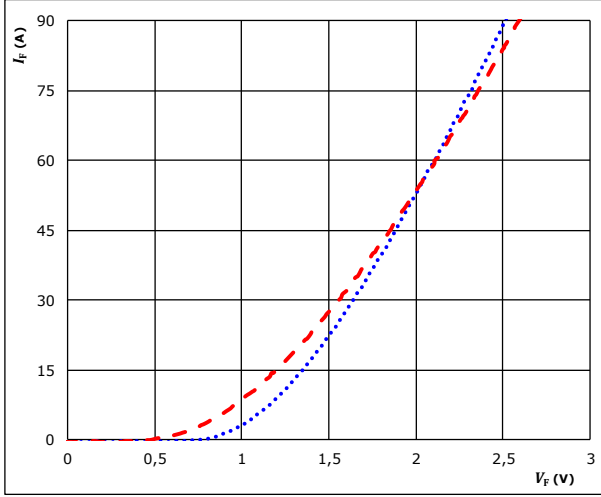


### Inverter Diode Characteristics

**figure 1.** FWD

Typical forward characteristics

$$I_F = f(V_F)$$

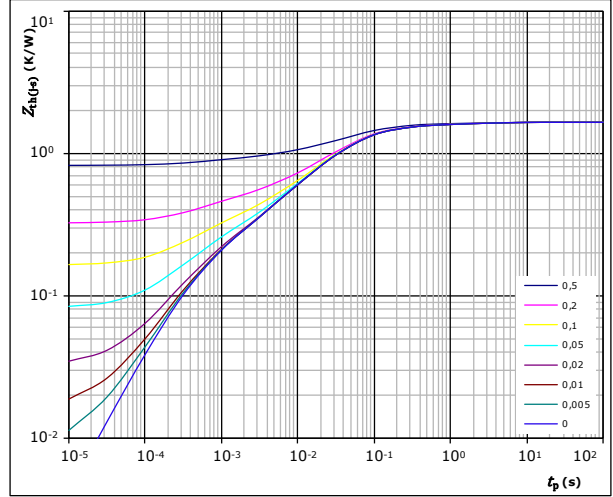


$t_p = 250 \mu s$   
 $T_j$ : 25 °C .....  
 150 °C - - - - -

**figure 2.** FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,63 \text{ K/W}$

FWD thermal model values

R (K/W)	$\tau$ (s)
7,13E-02	2,56E+00
1,55E-01	2,86E-01
7,25E-01	5,21E-02
3,93E-01	1,46E-02
1,57E-01	2,62E-03
1,32E-01	3,83E-04

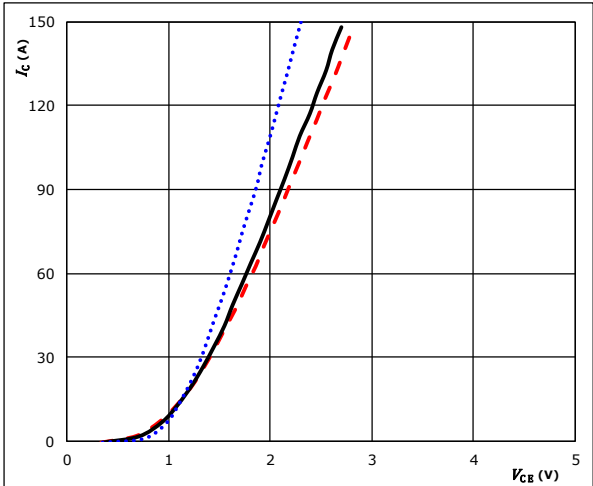


### PFC Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$I_C = f(V_{CE})$

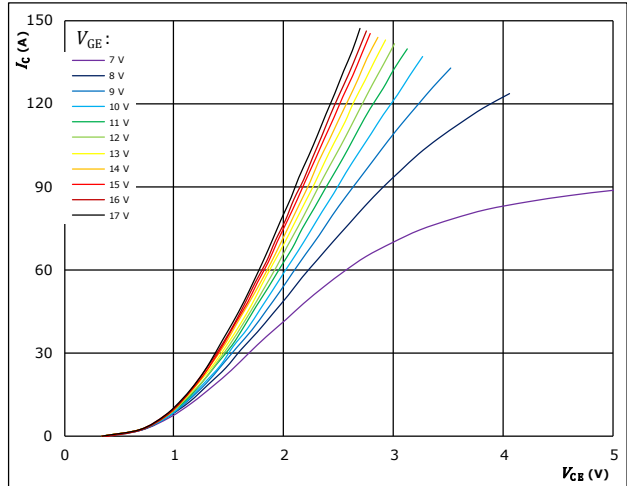


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ } ^\circ C$  (dotted blue line)  
 $125 \text{ } ^\circ C$  (solid black line)  
 $150 \text{ } ^\circ C$  (dashed red line)

**figure 2.** IGBT

Typical output characteristics

$I_C = f(V_{CE})$

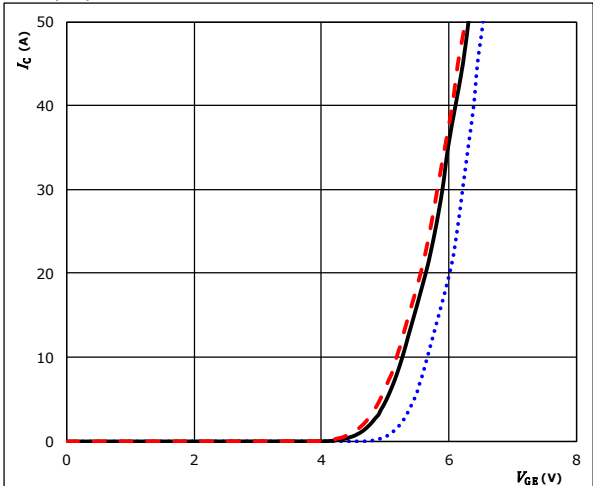


$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

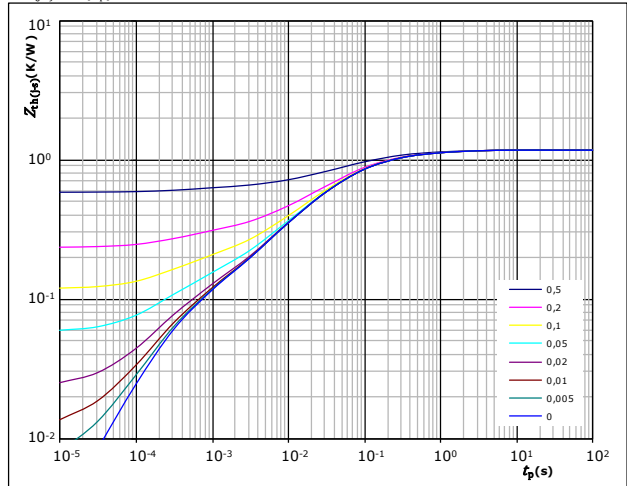


$t_p = 100 \mu s$   
 $V_{CE} = 3634 V$   
 $T_j: 25 \text{ } ^\circ C$  (dotted blue line)  
 $125 \text{ } ^\circ C$  (solid black line)  
 $150 \text{ } ^\circ C$  (dashed red line)

**figure 4.** IGBT

Transient thermal impedance as function of pulse duration

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$   
 $R_{th(j-s)} = 1,17 \text{ K/W}$   
 IGBT thermal model values

R (K/W)	$\tau$ (s)
9,21E-02	1,46E+00
2,50E-01	2,13E-01
4,87E-01	5,11E-02
2,29E-01	1,02E-02
4,67E-02	1,93E-03
6,92E-02	3,04E-04

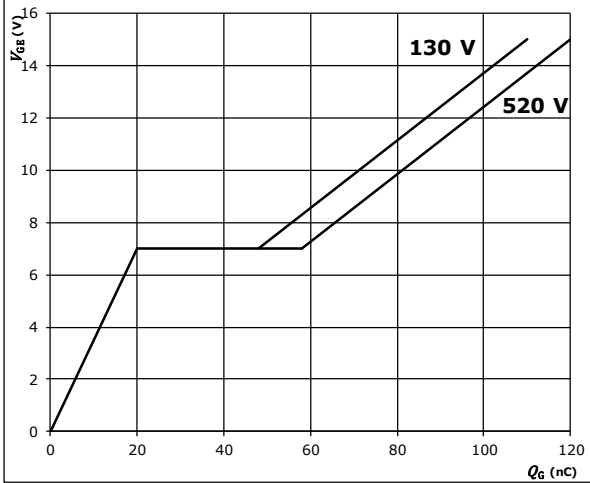


### PFC Switch Characteristics

**figure 5.** IGBT

Gate voltage vs gate charge

$V_{GE} = f(Q_G)$

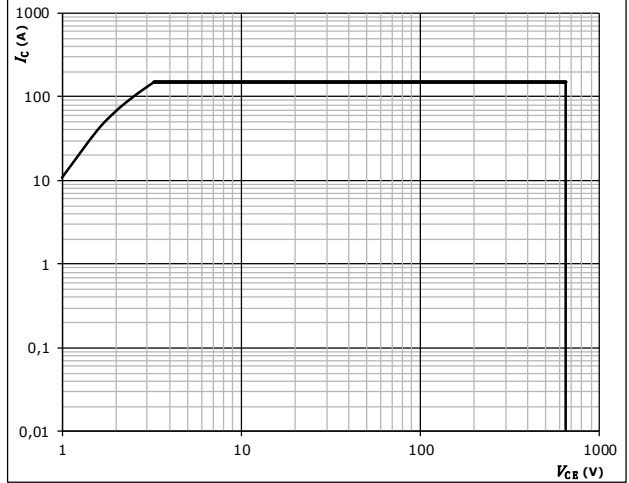


$I_C = 50$  A

**figure 6.** IGBT

Safe operating area

$I_C = f(V_{CE})$



$D =$  single pulse  
 $T_s = 80$  °C  
 $V_{GE} = \pm 15$  V  
 $T_j = T_{jmax}$

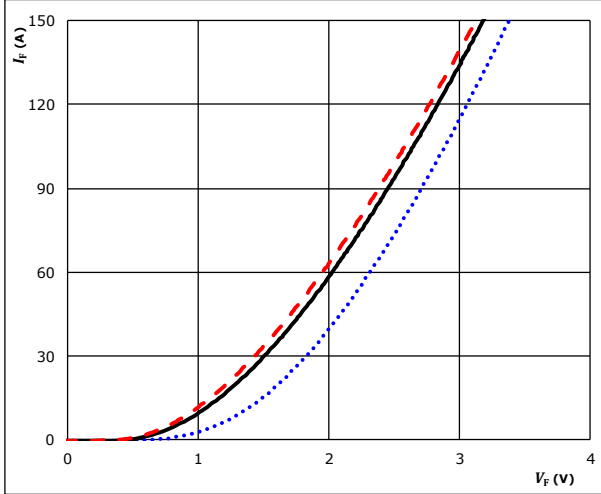


### PFC Diode Characteristics

**figure 1.** FWD

Typical forward characteristics

$$I_F = f(V_F)$$

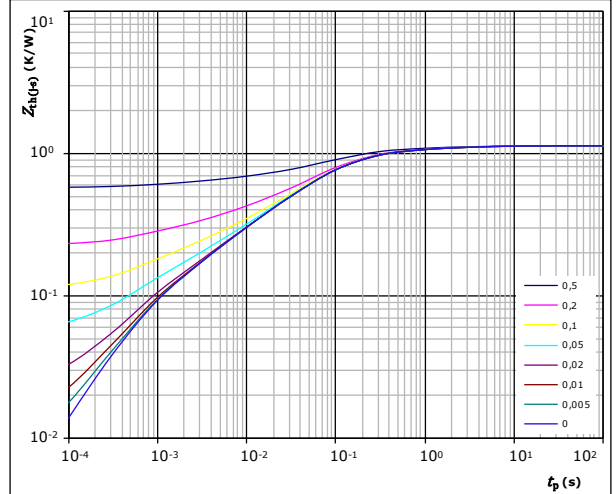


$t_p = 250 \mu s$   
 $T_j$ : 25 °C .....  
 125 °C ———  
 150 °C - - - -

**figure 2.** FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,14 \text{ K/W}$   
 FWD thermal model values

$R$ (K/W)	$\tau$ (s)
4,89E-02	4,95E+00
1,50E-01	5,95E-01
4,68E-01	1,06E-01
2,69E-01	3,10E-02
1,24E-01	5,12E-03
7,64E-02	7,25E-04



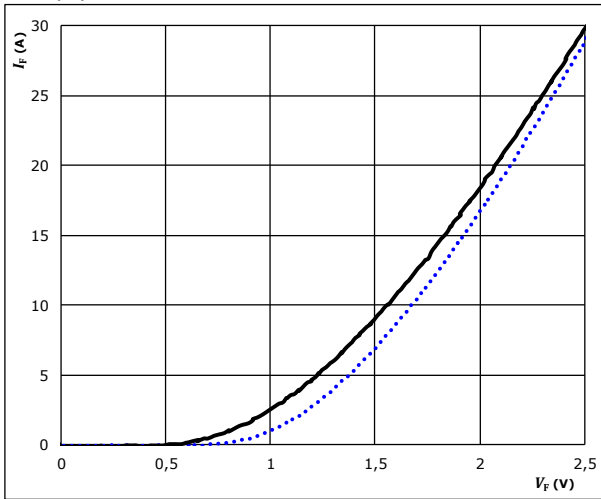


## PFC Sw. Protection Diode Characteristics

**figure 1.** FWD

Typical forward characteristics

$$I_F = f(V_F)$$

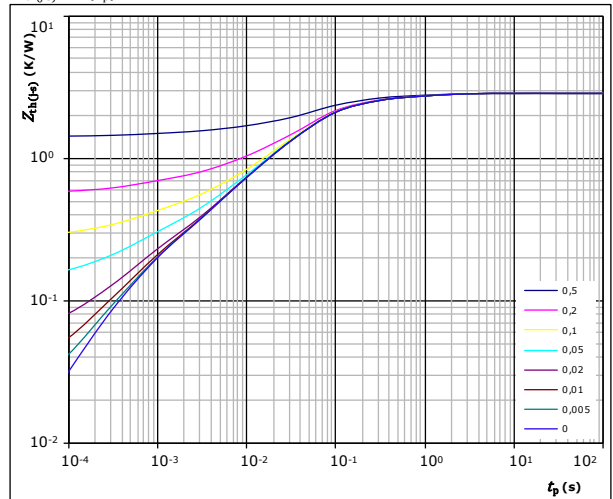


$t_p = 250 \mu s$   
 $T_j: 25 \text{ } ^\circ\text{C}$  (dotted line)  
 $125 \text{ } ^\circ\text{C}$  (solid line)

**figure 2.** FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 2,87 \text{ K/W}$   
FWD thermal model values

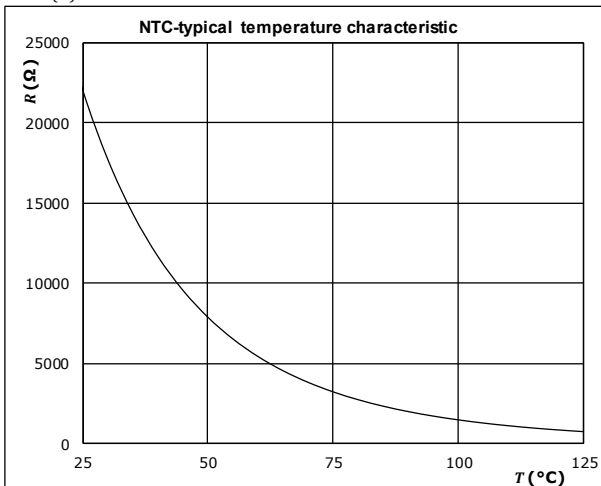
$R$ (K/W)	$\tau$ (s)
2,86E-01	2,80E+00
5,75E-01	4,47E-01
1,57E+00	1,18E-01
3,05E-01	1,46E-02
1,34E-01	1,45E-03

## Thermistor Characteristics

**figure 1.** Thermistor

Typical NTC characteristic as a function of temperature

$$R = f(T)$$



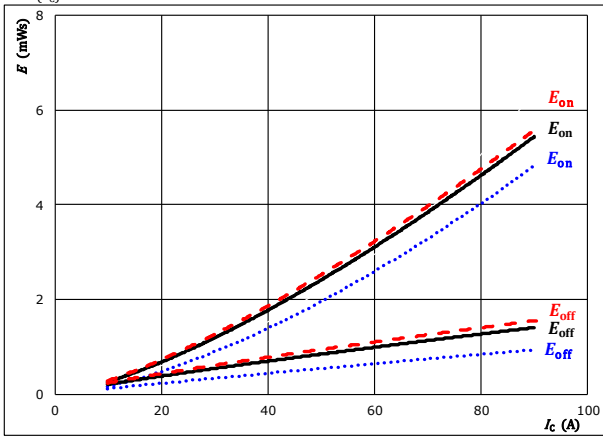


## Inverter Switching Characteristics

**figure 1.** IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$

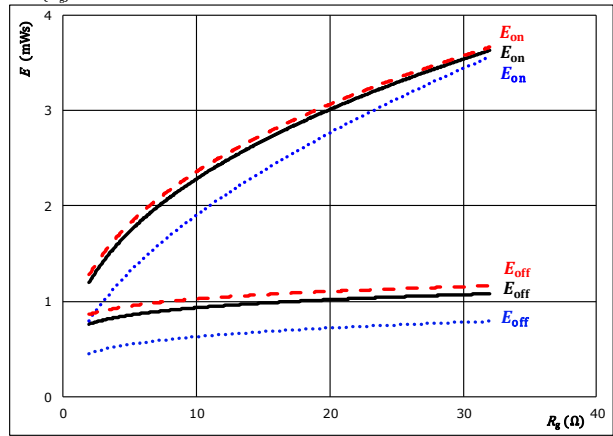


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g(on)} = 8$   $\Omega$   
 $R_{g(off)} = 8$   $\Omega$   
 $T_j: 25$  °C (dotted),  $125$  °C (solid),  $125$  °C (dashed)

**figure 2.** IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$

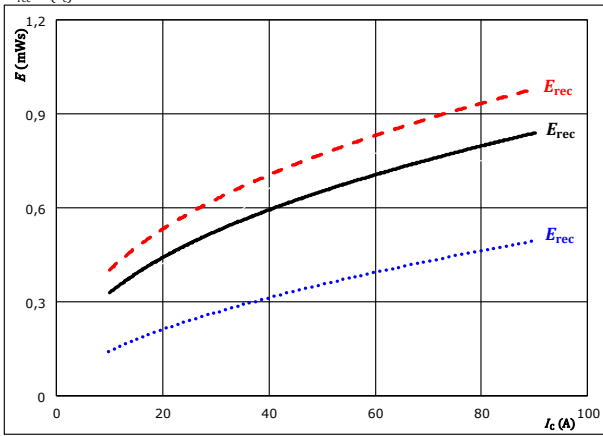


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A  
 $T_j: 25$  °C (dotted),  $125$  °C (solid),  $125$  °C (dashed)

**figure 3.** FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$

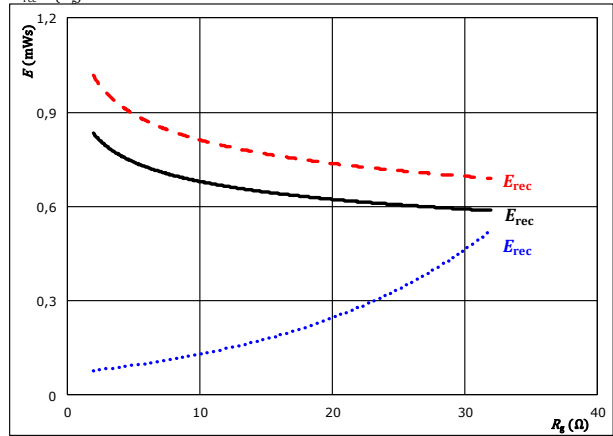


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g(on)} = 8$   $\Omega$   
 $T_j: 25$  °C (dotted),  $125$  °C (solid),  $125$  °C (dashed)

**figure 4.** FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A  
 $T_j: 25$  °C (dotted),  $125$  °C (solid),  $125$  °C (dashed)

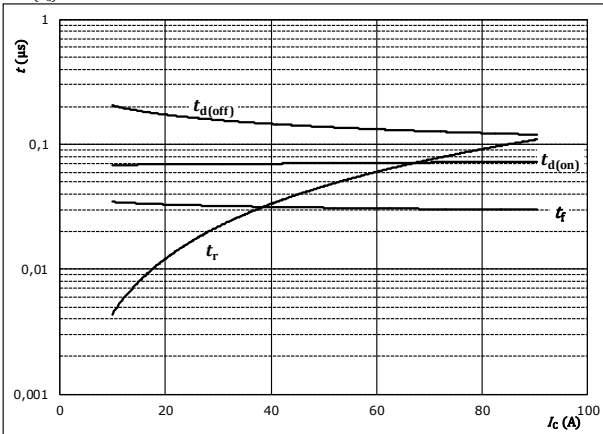


## Inverter Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



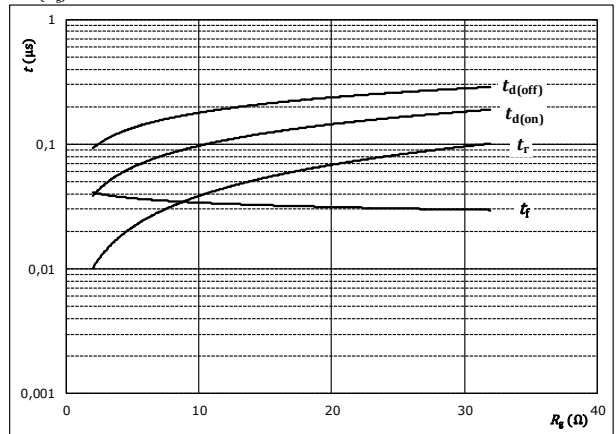
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω
$R_{goff} =$	8	Ω

**figure 6.** IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



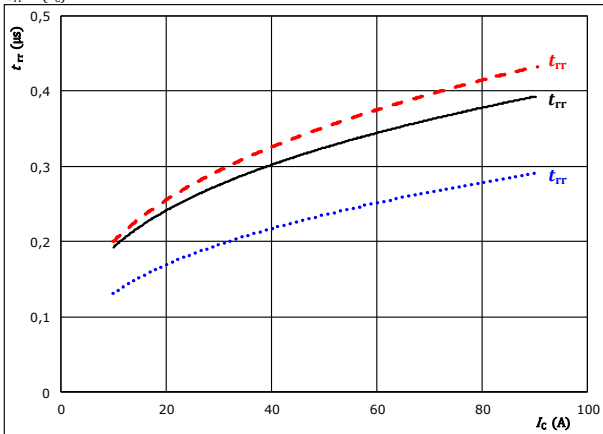
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	50	A

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

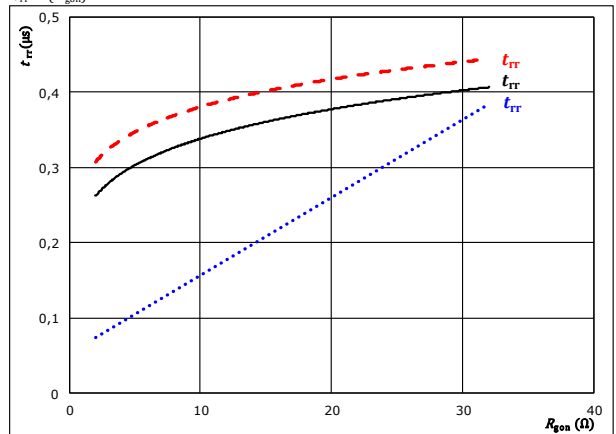
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω

$T_j:$	25 °C	.....
	125 °C	————
	125 °C	-----

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



With an inductive load at

$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	50	A

$T_j:$	25 °C	.....
	125 °C	————
	125 °C	-----

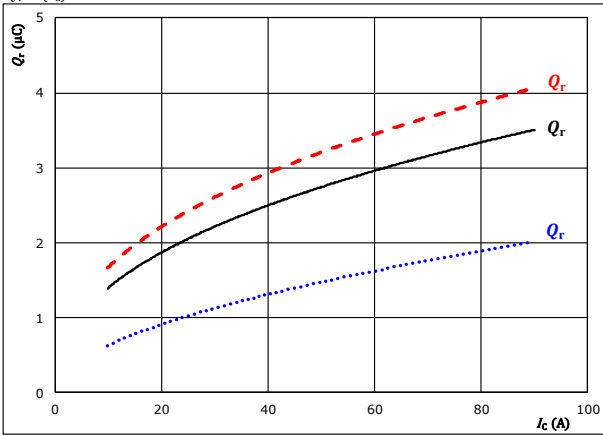


## Inverter Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

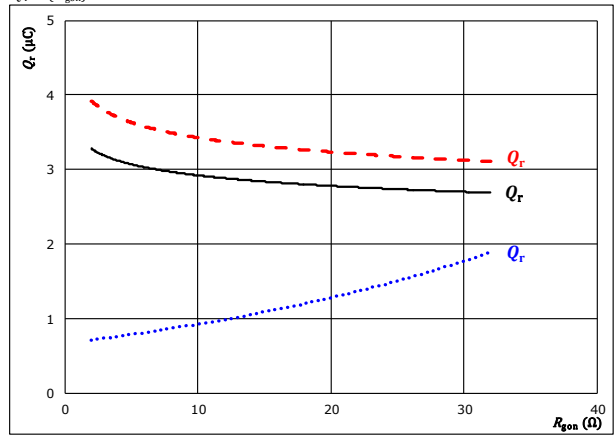


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$   $\Omega$   
 $T_j$ : 25 °C (blue dotted), 125 °C (black solid), 125 °C (red dashed)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$

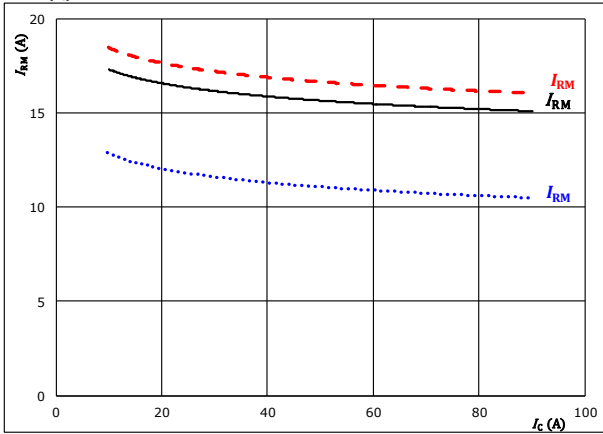


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A  
 $T_j$ : 25 °C (blue dotted), 125 °C (black solid), 125 °C (red dashed)

figure 11. FWD

Typical peak reverse recovery current current as a function of collector current

$$I_{RM} = f(I_c)$$

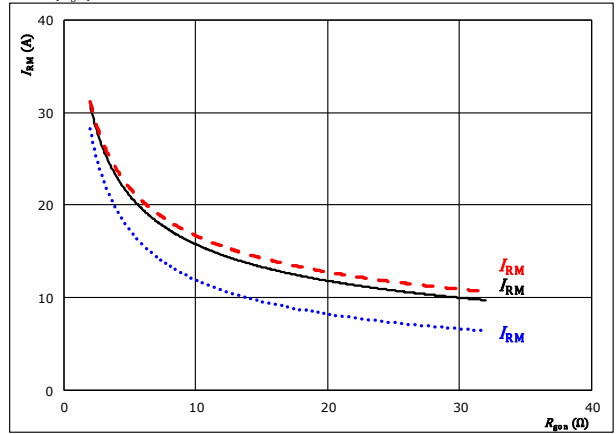


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$   $\Omega$   
 $T_j$ : 25 °C (blue dotted), 125 °C (black solid), 125 °C (red dashed)

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



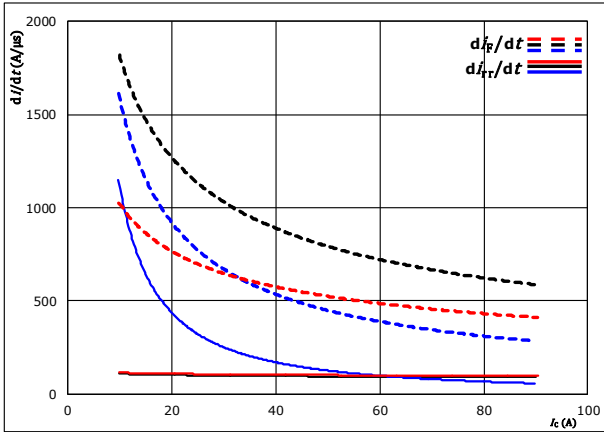
With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A  
 $T_j$ : 25 °C (blue dotted), 125 °C (black solid), 125 °C (red dashed)



## Inverter Switching Characteristics

**figure 13.** FWD

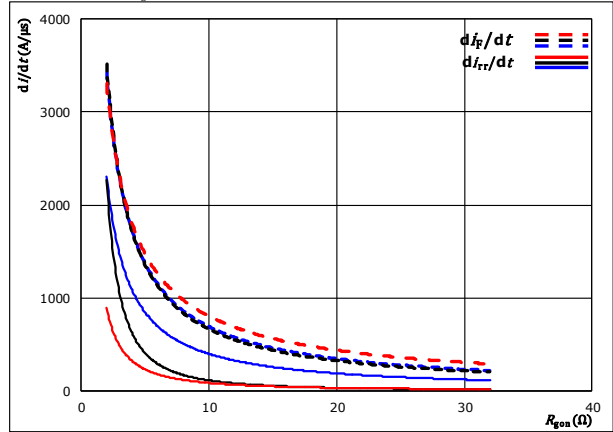
Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_{f}/dt, di_{rr}/dt = f(I_C)$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g\text{on}} = 8$   $\Omega$   
 $T_j = 25$  °C  
 $125$  °C

**figure 14.** FWD

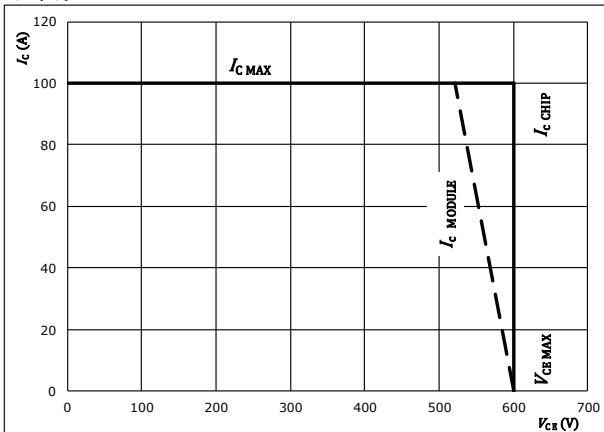
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor  
 $di_{f}/dt, di_{rr}/dt = f(R_{g\text{on}})$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 50$  A  
 $T_j = 25$  °C  
 $125$  °C

**figure 15.** IGBT

Reverse bias safe operating area  
 $I_C = f(V_{CB})$



At  
 $T_j = 125$  °C  
 $R_{g\text{on}} = 8$   $\Omega$   
 $R_{g\text{off}} = 8$   $\Omega$



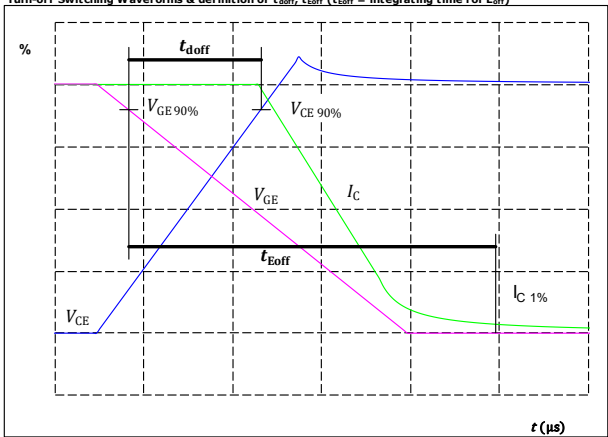
## Inverter Switching Definitions

**General conditions**

$T_j$	=	125 °C
$R_{gon}$	=	8 $\Omega$
$R_{goff}$	=	8 $\Omega$

**figure 1.** IGBT

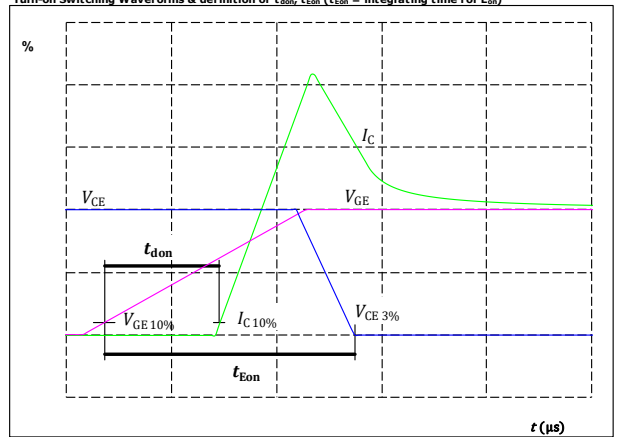
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_{doff} =$	134	ns

**figure 2.** IGBT

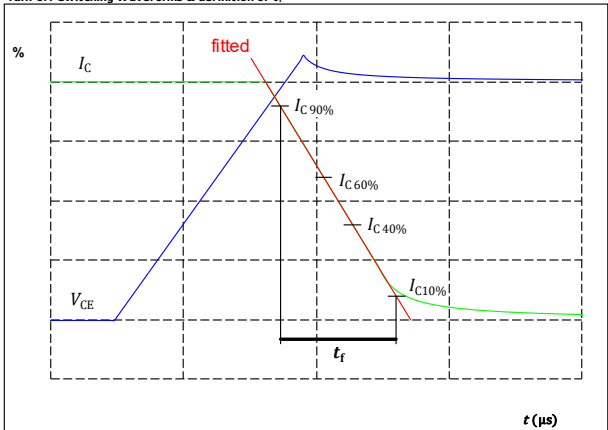
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_{don} =$	70	ns

**figure 3.** IGBT

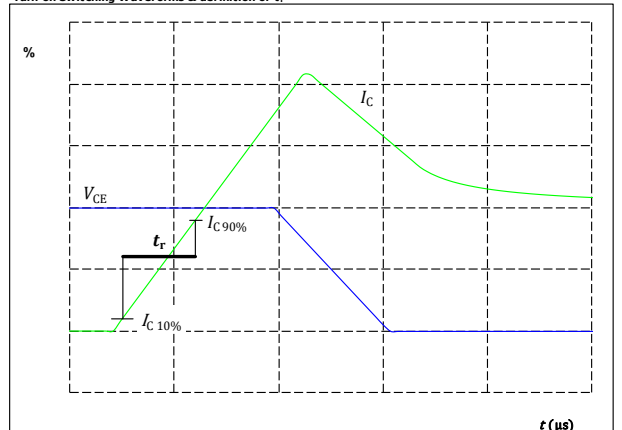
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_f =$	34	ns

**figure 4.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$



$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_r =$	43	ns

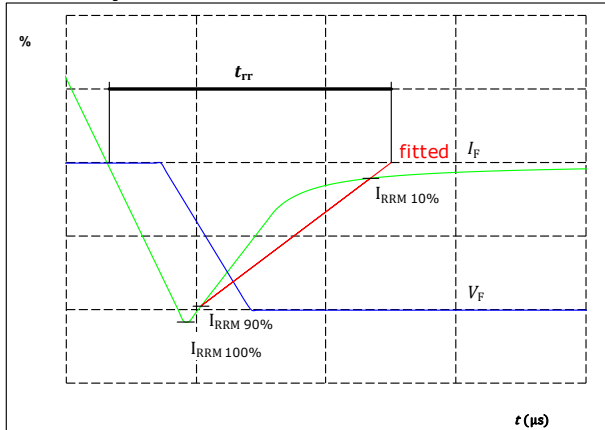


Vincotech

## Inverter Switching Characteristics

figure 5. FWD

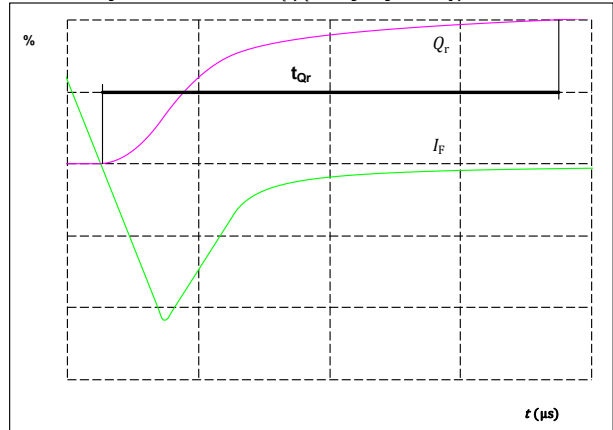
Turn-off Switching Waveforms & definition of  $t_{rr}$



$V_F(100\%) =$	350	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	16	A
$t_{rr} =$	332	ns

figure 6. FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr} =$  integrating time for  $Q_r$ )



$I_F(100\%) =$	50	A
$Q_r(100\%) =$	3,09	$\mu\text{C}$

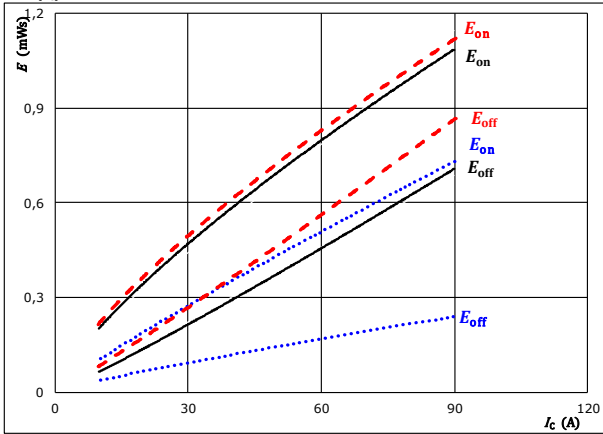


### PFC Switching Characteristics

**figure 1.** IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$

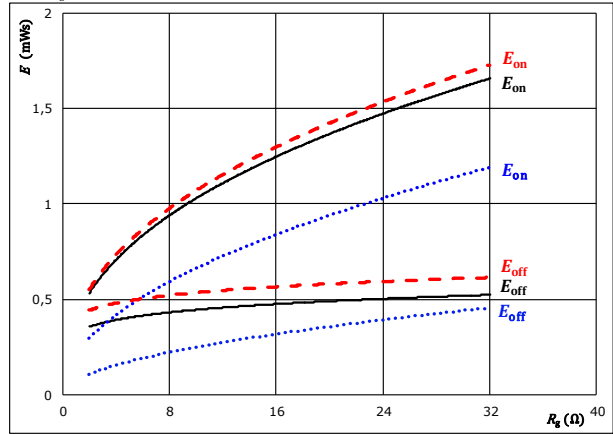


With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $R_{gon} = 4$   $\Omega$   
 $R_{goff} = 4$   $\Omega$   
 $T_j: 25$  °C  
 $125$  °C  
 $150$  °C

**figure 2.** IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$

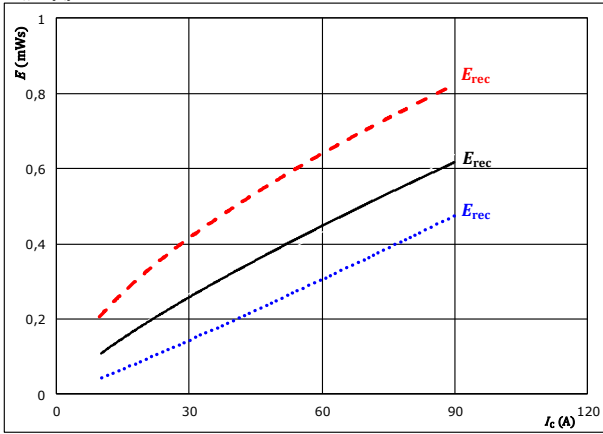


With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $I_c = 50$  A  
 $T_j: 25$  °C  
 $125$  °C  
 $150$  °C

**figure 3.** FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$

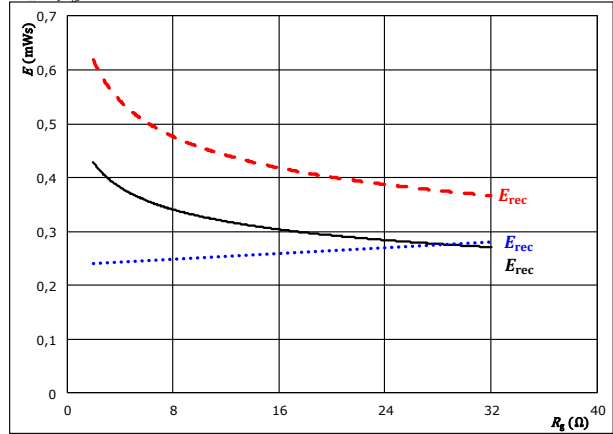


With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j: 25$  °C  
 $125$  °C  
 $150$  °C

**figure 4.** FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $I_c = 50$  A  
 $T_j: 25$  °C  
 $125$  °C  
 $150$  °C



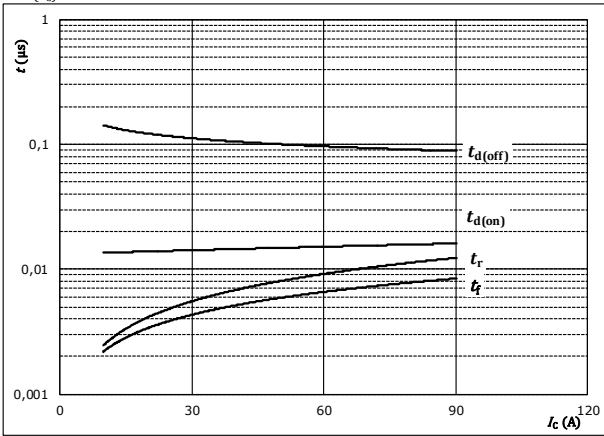


### PFC Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



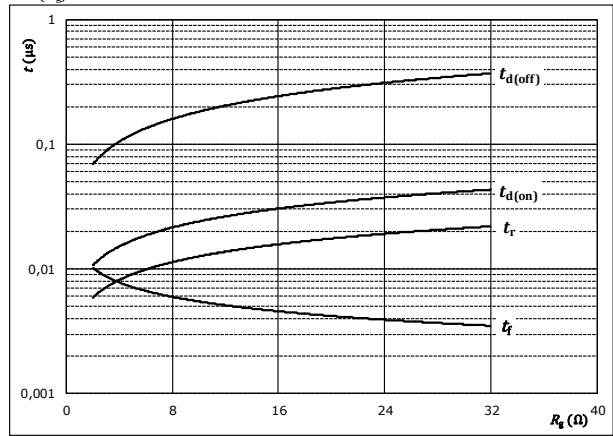
With an inductive load at

- $T_j = 150$  °C
- $V_{CE} = 400$  V
- $V_{GE} = 0 / 15$  V
- $R_{gon} = 4$  Ω
- $R_{goff} = 4$  Ω

**figure 6.** IGBT

Typical switching times as a function of gate resistor

$t = f(R_g)$



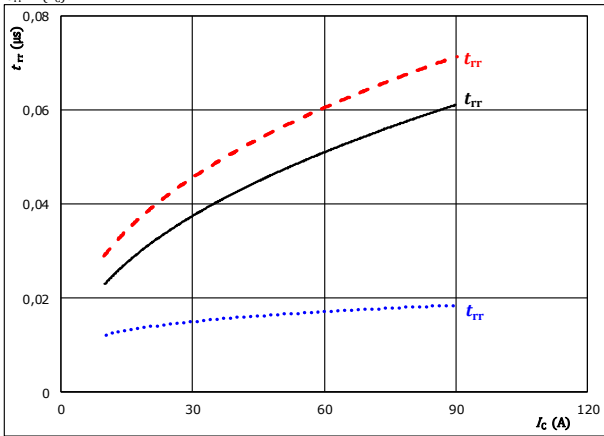
With an inductive load at

- $T_j = 150$  °C
- $V_{CE} = 400$  V
- $V_{GE} = 0 / 15$  V
- $I_C = 50$  A

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



With an inductive load at

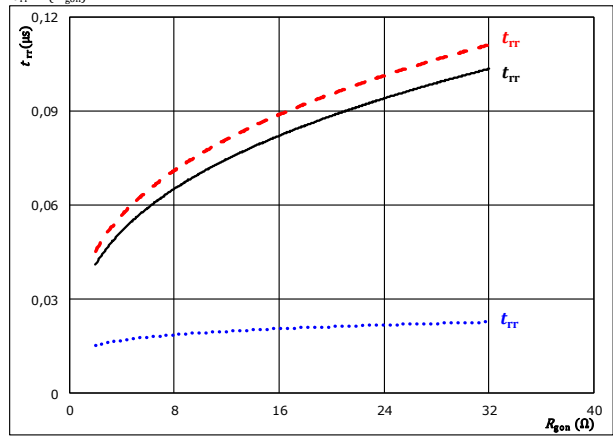
- $V_{CE} = 400$  V
- $V_{GE} = 0 / 15$  V
- $R_{gon} = 4$  Ω

- $T_j: 25$  °C (dotted blue)
- $125$  °C (solid black)
- $150$  °C (dashed red)

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



With an inductive load at

- $V_{CE} = 400$  V
- $V_{GE} = 0 / 15$  V
- $I_C = 50$  A

- $T_j: 25$  °C (dotted blue)
- $125$  °C (solid black)
- $150$  °C (dashed red)

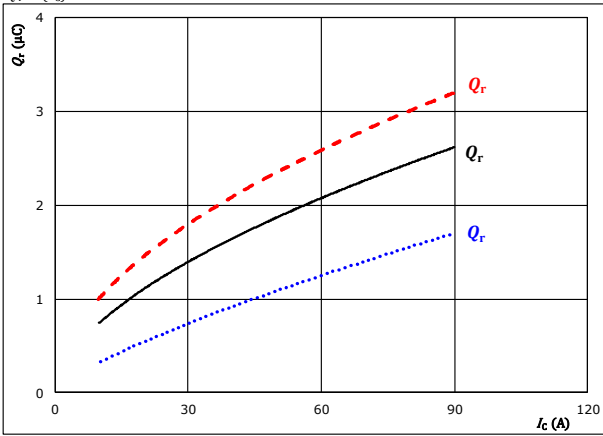


## PFC Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

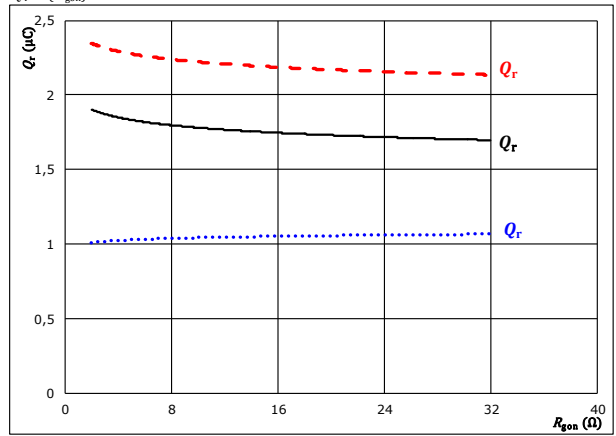


With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$

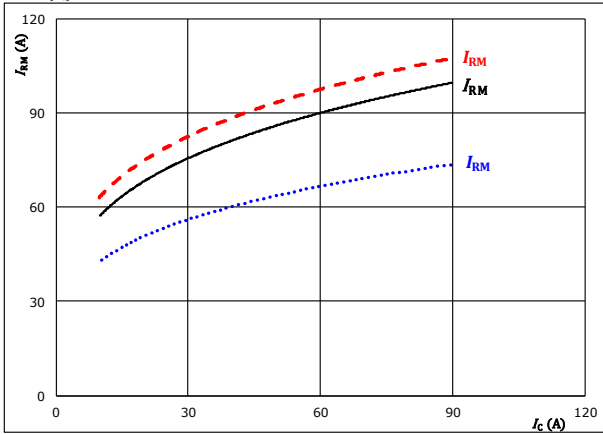


With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $I_c = 50$  A  
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

figure 11. FWD

Typical peak reverse recovery current current as a function of collector current

$$I_{RM} = f(I_c)$$

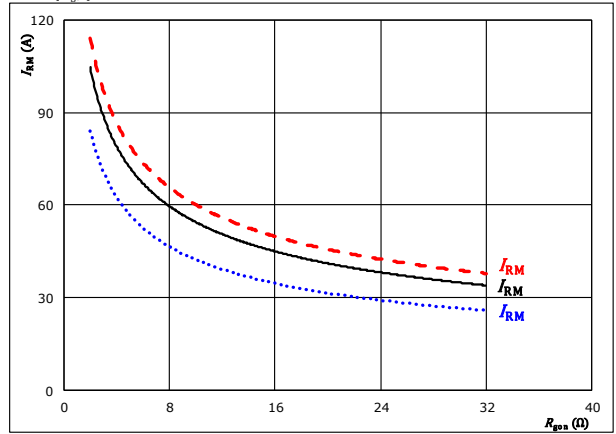


With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



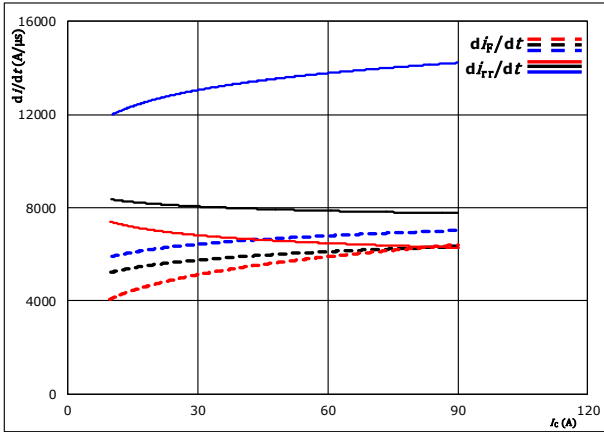
With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{GE} = 0 / 15$  V  
 $I_c = 50$  A  
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)



### PFC Switching Characteristics

**figure 13.** FWD

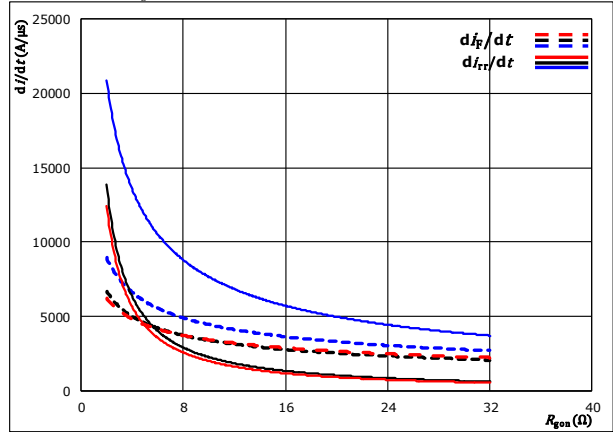
Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{CE} = 0 / 15$  V  
 $R_{g\text{on}} = 4$   $\Omega$   
 $T_j = 25$  °C  
 $150$  °C

**figure 14.** FWD

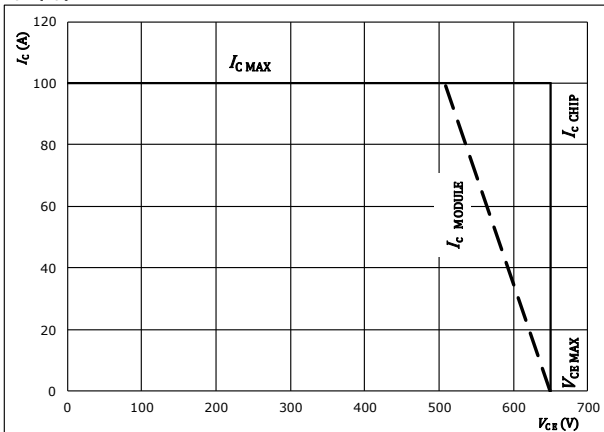
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{g\text{on}})$



With an inductive load at  
 $V_{CE} = 400$  V  
 $V_{CE} = 0 / 15$  V  
 $I_c = 50$  A  
 $T_j = 25$  °C  
 $150$  °C

**figure 15.** IGBT

Reverse bias safe operating area  
 $I_c = f(V_{CE})$



At  
 $T_j = 125$  °C  
 $R_{g\text{on}} = 4$   $\Omega$   
 $R_{g\text{off}} = 4$   $\Omega$



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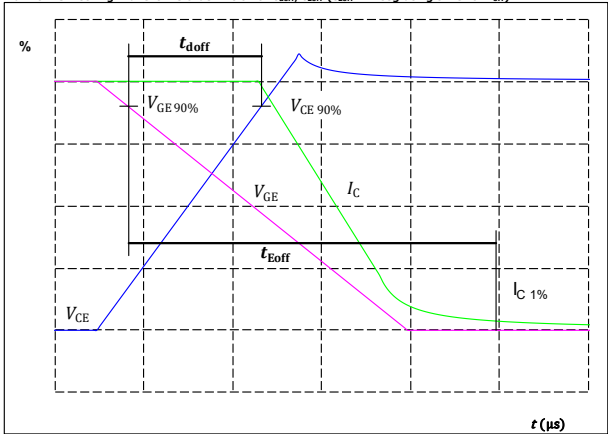
## PFC Switching Definitions

**General conditions**

$T_j$	=	125 °C
$R_{gon}$	=	4 $\Omega$
$R_{goff}$	=	4 $\Omega$

**figure 1.** IGBT

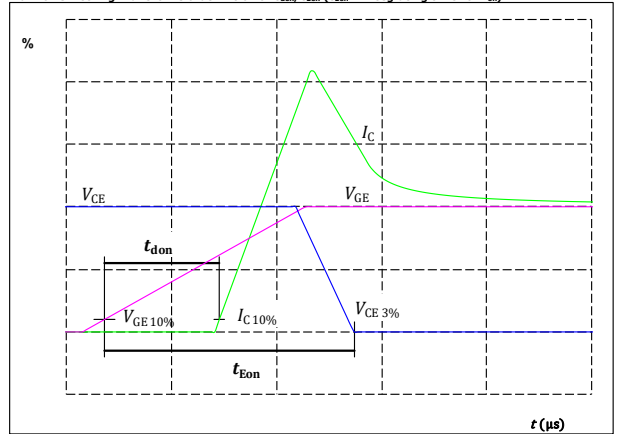
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{CE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{doff} =$	97	ns

**figure 2.** IGBT

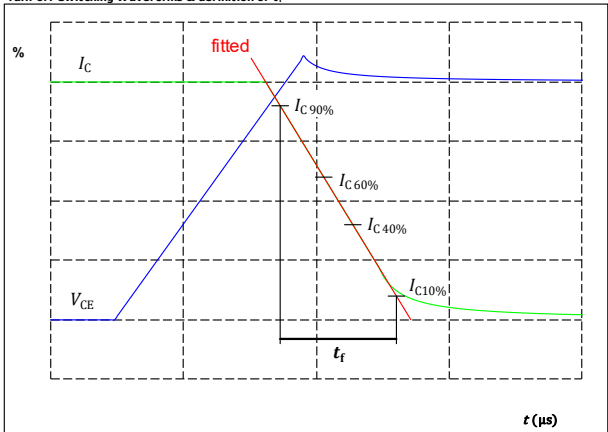
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{CE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{don} =$	13	ns

**figure 3.** IGBT

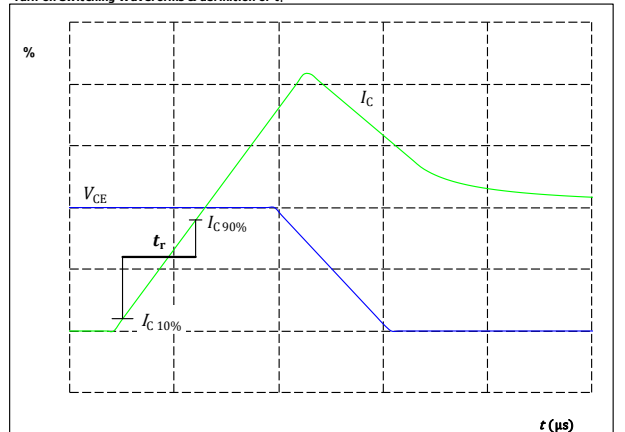
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_f =$	6	ns

**figure 4.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$



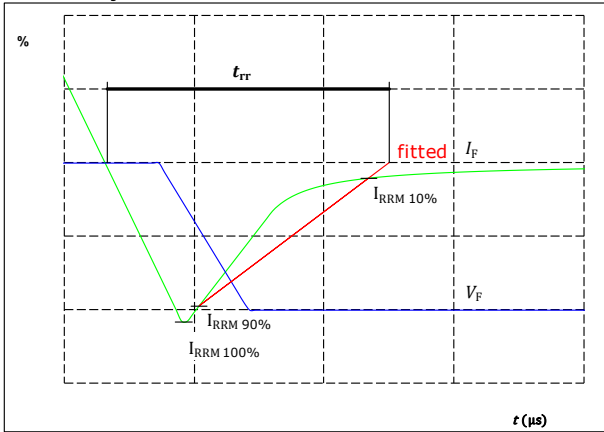
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_r =$	7	ns



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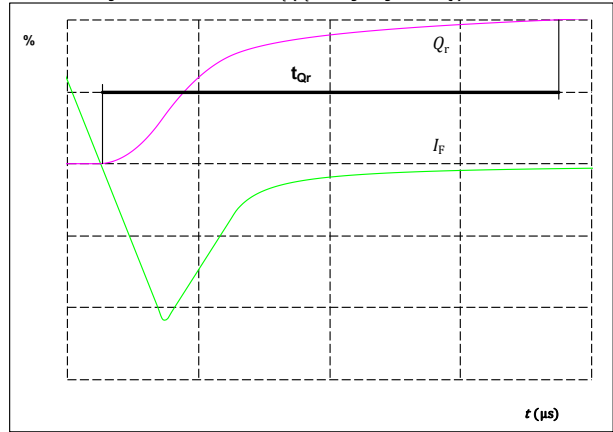
### PFC Switching Characteristics

**figure 5.** FWD  
Turn-off Switching Waveforms & definition of  $t_{rr}$



$V_F(100\%) =$	400	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	83	A
$t_{rr} =$	47	ns

**figure 6.** FWD  
Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr} =$  integrating time for  $Q_r$ )



$I_F(100\%) =$	50	A
$Q_r(100\%) =$	1,79	$\mu\text{C}$



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Ordering Code & Marking																																
<b>Version</b>				<b>Ordering Code</b>																												
without thermal paste 12mm housing with Press-fit pins				10-PG06PPA050SJ-LJ04B08T																												
with thermal paste 12mm housing with Press-fit pins				10-PG06PPA050SJ-LJ04B08T-/3/																												
<table border="1"> <thead> <tr> <th rowspan="3">Text</th> <th colspan="2">Name</th> <th>Date code</th> <th>UL &amp; VIN</th> <th>Lot</th> <th>Serial</th> </tr> <tr> <td colspan="2">NN-NNNNNNNNNNNNNN-TTTTTTW</td> <td>WWYY</td> <td>UL VIN</td> <td>LLLLL</td> <td>SSSS</td> </tr> <tr> <th>Type&amp;Ver</th> <th>Lot number</th> <th>Serial</th> <th>Date code</th> <td></td> <td></td> </tr> </thead> <tbody> <tr> <td>Datamatrix</td> <td>TTTTTTW</td> <td>LLLLL</td> <td>SSSS</td> <td>WWYY</td> <td></td> <td></td> </tr> </tbody> </table>							Text	Name		Date code	UL & VIN	Lot	Serial	NN-NNNNNNNNNNNNNN-TTTTTTW		WWYY	UL VIN	LLLLL	SSSS	Type&Ver	Lot number	Serial	Date code			Datamatrix	TTTTTTW	LLLLL	SSSS	WWYY		
Text	Name		Date code	UL & VIN	Lot	Serial																										
	NN-NNNNNNNNNNNNNN-TTTTTTW		WWYY	UL VIN	LLLLL	SSSS																										
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Datamatrix	TTTTTTW	LLLLL	SSSS	WWYY																												

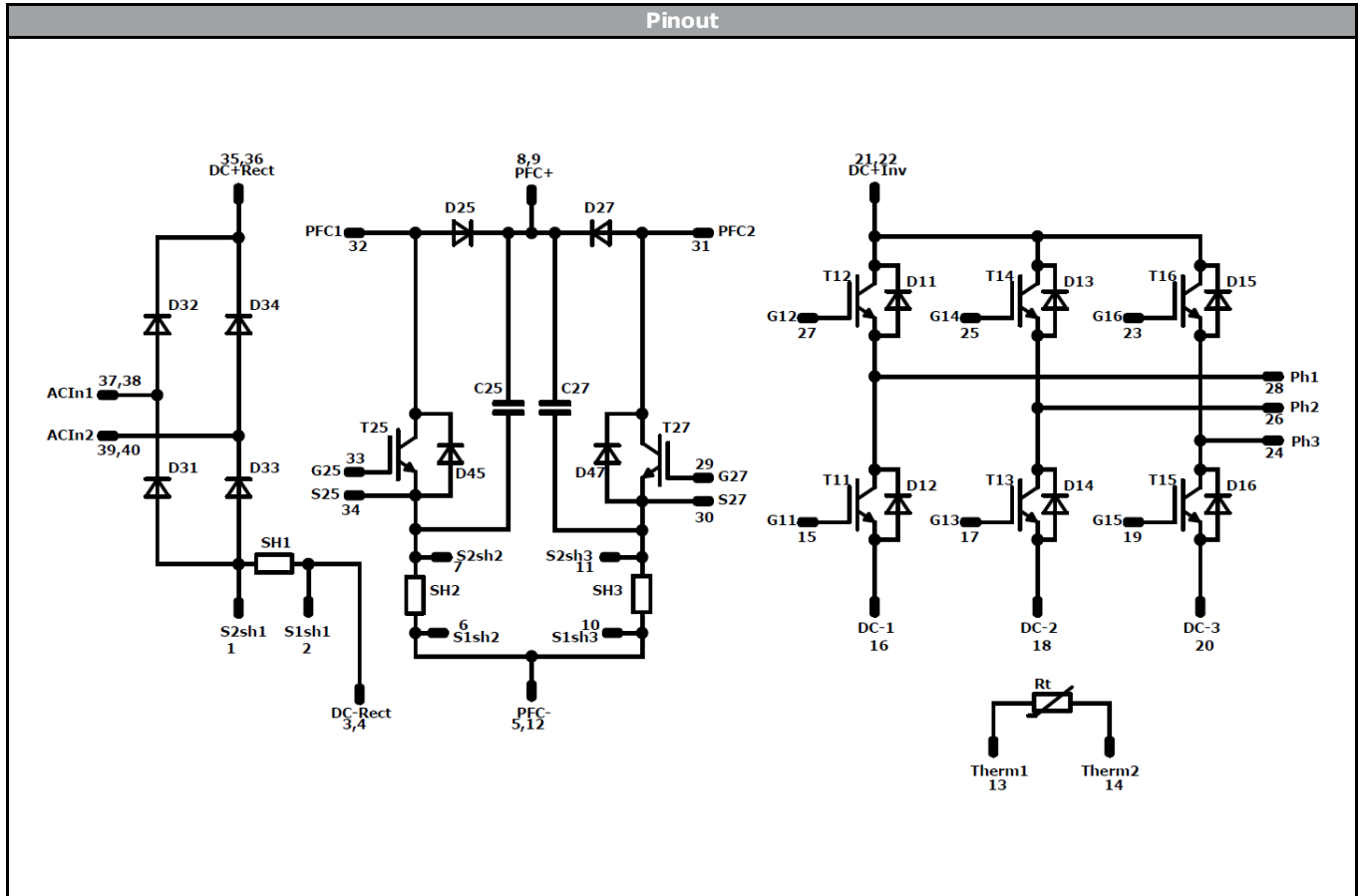
Pin table			
Pin	X	Y	Function
1	50,5	7,4	S2sh1
2	49,5	4,4	S1sh1
3	45,5	0	DC-Rect
4	42,8	0	DC-Rect
5	38,5	0	PFC-
6	38,5	3	S1sh2
7	38,5	6	S2sh2
8	31,8	1,2	PFC+
9	31,8	3,9	PFC+
10	25,1	1,9	S1sh3
11	23,1	4,9	S2sh3
12	22,1	0	PFC-
13	19,1	0	Therm1
14	19,1	3	Therm2
15	15	0	G11
16	12	0	DC-1
17	9	0	G13
18	6	0	DC-2
19	3	0	G15
20	0	0	DC-3
21	0	15,15	DC+Inv
22	0	17,85	DC+Inv
23	0	25,5	G16
24	0	28,5	Ph3
25	7,7	25,5	G14
26	7,7	28,5	Ph2
27	15,4	25,5	G12
28	15,4	28,5	Ph1
29	21,7	16,3	G27
30	21,7	19,3	S27
31	23,4	28,5	PFC2
32	31,1	28,5	PFC1
33	32,9	19,3	G25
34	35,9	19,3	S25
35	39,1	28,5	DC+Rect
36	41,8	28,5	DC+Rect
37	49,8	28,5	ACIn1
38	52,5	28,5	ACIn1
39	44,3	17,2	ACIn2
40	44,3	14,45	ACIn2

**Outline**

Tolerance of pinpositions: ±0.4mm at the end of pins  
Dimension of coordinate axis is only offset without tolerance



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<b>Identification</b>					
<b>ID</b>	<b>Component</b>	<b>Voltage</b>	<b>Current</b>	<b>Function</b>	<b>Comment</b>
D31, D32, D33, D34	FWD	1600 V	60 A	Rectifier Diode	
T11, T12, T13, T14, T15, T16	IGBT	600 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	30 A	Inverter Diode	
T25, T27	IGBT	650 V	50 A	PFC Switch	
D25, D27	FWD	650 V	50 A	PFC Diode	
D45, D47	FWD	650 V	10 A	PFC Sw. Protection Diode	
C25, C27	Capacitor	630 V		Capacitor (PFC)	
SH1	Shunt		32 A	PFC Shunt	
SH2, SH3	Shunt		32 A	Shunt	
Rt	Thermistor			Thermistor	




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Packaging instruction			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-PG06PPA050SJ-LJ04B08T-D2-14	16 May. 2019	Correct Ic, Ptot and Rth(j-s) for Inverter Switch Correction of Ic/If values	1, 5, 11 1, 2, 3

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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